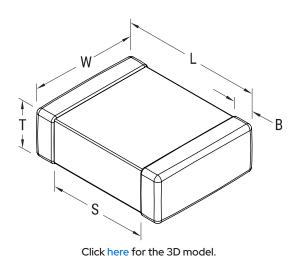




ESD SMD Comm COG, Ceramic, 4,700 pF, 10%, 25 VDC, COG, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I, 0805, 0.6 mm



General Information	
Series	ESD SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I
Features	Temperature Stable, Low ESR, Class I
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	13 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0805
L	2mm +/-0.3mm
W	1.25mm +/-0.3mm
Т	0.9mm +/-0.10mm
S	0.6mm MIN
В	0.5mm +/-0.25mm

S	0.6mm MIN
В	0.5mm +/-0.25mm
Packaging Specifications	
Packaging	Bulk, Bag

Packaging Quantity

4,700 pF
1 kHz 1.0Vrms
10%
25 VDC
25,000 V ESD Level
62.5 VDC
-55/+125°C
COG
30 ppm/C, 1kHz 1.0Vrms
0.1% 1 kHz 1.0Vrms
0% Loss/Decade Hour
100 GOhms

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